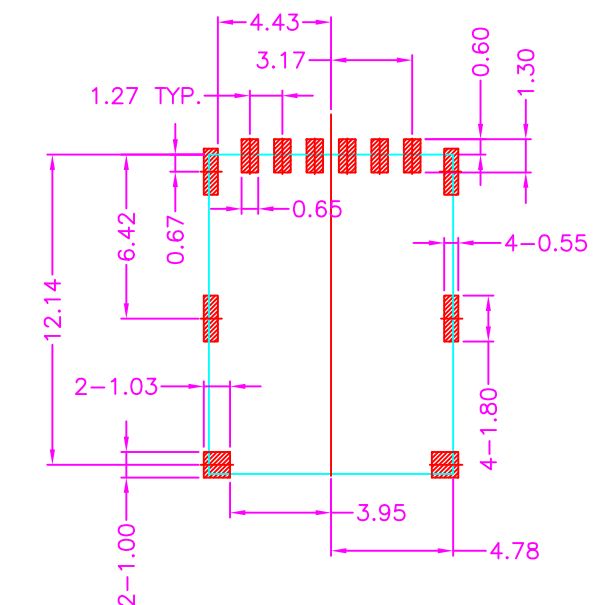
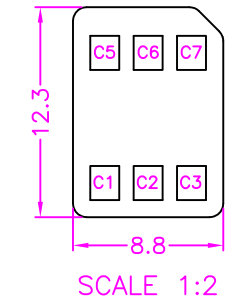


NANO SIM CARD PIN MAP

6P	DEACRIPTION
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	Vpp
C7	I/O
C8	Reserved

NANO SIM CARD PAD



P.C.B LAYOUT TOP VIEW  $\pm 0.05$

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)  
 SHELL: STAINLESS STEEL, NICKEL PLATING  
 SOLDER PAD: STAINLESS STEEL, GOLD FLASH  
 TERMINAL: COPPER ALLOY, GOLD PLATING

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX  
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE  
 CONTACT RESISTANCE: 100m OHMS MAX  
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V  
 OPERATION TEMPERATURE:  $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$

PART NUMBER:  
**4MCRB - 0 6 \* - 1 2 8**

SERIES \_\_\_\_\_ TAPE REEL PACKAGE

NO. OF POS. \_\_\_\_\_

CONTACT PLATED OPTION \_\_\_\_\_

- 1: GOLD FLASH
- 3: 3u" GOLD
- 5: 5u" GOLD
- 6: 10u" GOLD
- 7: 15u" GOLD
- 9: 30u" GOLD
- 13: 8u" GOLD

<p><b>Cyberconn Technology Co., Ltd.</b>                  www.cyberconn.com.tw Tel:+886-3-4951314</p>						
TOLERANCES		MEMORY CARD SERIES				
X.X $\pm 0.3$		TITLE NANO SIM CARD, 6PIN, PCB MOUNT, SMT				
X.XX $\pm 0.2$		METAL SHIELD, FEMALE, H=1.25mm				
X.XXX $\pm 0.1$		DRAWN BY		CHECKED BY		APPROVED BY
Angle $\pm 5^{\circ}$		Tina		Lion		Benson
		UNIT	SCALE	SIZE	DRAW NO.	REV. Sheet
10184		MM	NONE	A4	4MCRB-008	A 1/1

A	RELEASE	2016.6.30
REV.	DESCRIPTION	DATE